



INTEL[®] MAX[®] 10 FPGAS PRODUCT TABLE

PRODUCT LINE	10M02	10M04	10M08	10M16	10M25	10M40	10M50
LEs (K)	2	4	8	16	25	40	50
Block memory (Kb)	108	189	378	549	675	1,260	1,638
User flash memory ¹ (KB)	12	16 – 156	32 – 172	32 – 296	32 – 400	64 – 736	64 – 736
18 x 18 multipliers	16	20	24	45	55	125	144
Phase-locked loops (PLLs) ²	1, 2	1, 2	1, 2	1, 4	1, 4	1, 4	1, 4
Internal configuration	Single	Dual	Dual	Dual	Dual	Dual	Dual
Analog-to-digital converter (ADC), temperature sensing diode (TSD) ³	-	1, 1	1, 1	1, 1	2, 1	2, 1	2, 1
External memory interface (EMIF)	Yes ⁴	Yes ⁴	Yes ⁴	Yes ⁵	Yes ⁵	Yes ⁵	Yes ⁵

Package Options and I/O Pins: Feature Set Options, GPIO, True LVDS Transceiver/Receiver

V36 (D) ⁶	WLCSP (3 mm, 0.4 mm pitch)	C, 27, 3/7	-	-	-	-	-	-
V81 (D) ⁷	WLCSP (4 mm, 0.4 mm pitch)	-	-	C/F, 56, 7/17	-	-	-	-
F256 (D)	FBGA (17 mm, 1.0 mm pitch)	-	C/A, 178, 13/54	C/A, 178, 13/54	C/A, 178, 13/54	C/A, 178, 13/54	C/A, 178, 13/54	C/A, 178, 13/54
U324 (D)	UBGA (15 mm, 0.8 mm pitch)	C, 160, 9/47	C/A, 246, 15/81	C/A, 246, 15/81	C/A, 246, 15/81	-	-	-
F484 (D)	FBGA (23 mm, 1.0 mm pitch)	-	-	C/A, 250, 15/83	C/A, 320, 22/116	C/A, 360, 24/136	C/A, 360, 24/136	C/A, 360, 24/136
F672 (D)	FBGA (27 mm, 1.0 mm pitch)	-	-	-	-	-	C/A, 500, 30/192	C/A, 500, 30/192
E144 (S) ⁶	EQFP (22 mm, 0.5 mm pitch)	C, 101, 7/27	C/A, 101, 10/27	C/A, 101, 10/27	C/A, 101, 10/27	C/A, 101, 10/27	C/A, 101, 10/28	C/A, 101, 10/28
M153 (S)	MBGA (8 mm, 0.5 mm pitch) ⁸	C, 112, 9/29	C/A, 112, 9/29	C/A, 112, 9/29	-	-	-	-
U169 (S)	UBGA (11 mm, 0.8 mm pitch)	C, 130, 9/38	C/A, 130, 9/38	C/A, 130, 9/38	C/A, 130, 9/38	-	-	-

Notes:

1. Additional user flash may be available, depending on configuration options.
2. The number of PLLs available is dependent on the package option.
3. Availability of the ADC or TSD varies by package type. Smaller pin-count packages do not have access to the ADC hard IP.
4. SRAM only.
5. SRAM, DDR3 SDRAM, DDR2 SDRAM, or LPDDR2.
6. "D" = Dual power supply (1.2 V/2.5 V), "S" = Single power supply (3.3 V or 3.0 V).
7. V81 package does not support analog feature set. 10M08 V81 F devices support dual image with RSU.
8. "Easy PCB" utilizes 0.8 mm PCB design rules.
9. All data is correct at the time of printing, and may be subject to change without prior notice. For the latest information, please visit www.altera.com.

C, 27, 3/7 Indicates feature set options, GPIO count, and LVDS transmitter or receiver count. Feature set options: C = Compact (single image), F = Flash (dual image with RSU), A = Analog (analog features block). Each has added premiums.

Indicates pin migration.